

DCR1021SF

Phase Control Thyristor

Target Information

DS5436-1.0 March 2001

FEATURES

- Double Side Cooling
- High Surge Capability
- Low Inductance Internal Construction

APPLICATIONS

- High Power Converters
- DC Motor Control
- High Voltage Power Supplies

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V _{DRM} and V _{DRM} V	Conditions
DCR1021SF65	6500	$T_{vi} = 0^{\circ} \text{ to } 125^{\circ}\text{C},$
DCR0121SF64	6400	$I_{DRM} = I_{RRM} = 150 \text{mA},$
DCR1021SF63	6300	V_{DRM} , V_{RRM} $t_p = 10ms$,
DCR1021SF62	6200	V _{DSM} & V _{RSM} =
DCR1021SF61	6100	V _{DRM} & V _{RRM} + 100V
DCR1021SF60	6000	respectively

Lower voltage grades available.

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR1021SF63

Note: Please use the complete part number when ordering and quote this number in any future correspondance relating to your order.

KEY PARAMETERS

V_{DRM}		6500V
I _{T(AV)}	(max)	840A
I _{TSM}	(max)	14000A
dV/dt		1000V/ μs
dl/dt		100Α/ μ s

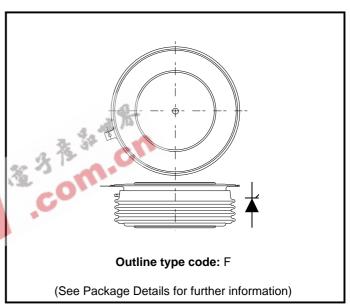


Fig. 1 Package outline



CURRENT RATINGS

$T_{case} = 60$ °C unless stated otherwise.

Symbol	Parameter	Test Conditions	Max.	Units		
Double Side	Double Side Cooled					
I _{T(AV)}	Mean on-state current	Half wave resistive load	840	А		
I _{T(RMS)}	RMS value	-	1320	Α		
I _T	Continuous (direct) on-state current	-	1230	Α		
Single Side	Single Side Cooled					
I _{T(AV)}	Mean on-state current	Half wave resistive load	610	А		
I _{T(RMS)}	RMS value	-	960	А		
I _T	Continuous (direct) on-state current	- 4-	845	А		

$T_{case} = 80^{\circ}C$ unless stated otherwise.

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T _{case} = 80°C ι	unless stated otherwise.	3 3 m.cn		
Symbol	Parameter	Test Conditions	Max.	Units
Double Sid	le Cooled			•
I _{T(AV)}	Mean on-state current	Half wave resistive load	670	А
I _{T(RMS)}	RMS value	-	1050	А
I _T	Continuous (direct) on-state current	-	960	А
Single Side	e Cooled			
I _{T(AV)}	Mean on-state current	Half wave resistive load	480	А
I _{T(RMS)}	RMS value	-	750	А
I _T	Continuous (direct) on-state current	-	650	А



SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine, T _{case} = 125°C	11.0	kA
l²t	I ² t for fusing	V _R = 50% V _{RRM} - 1/4 sine	0.6 x 10 ⁶	A ² s
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine, T _{case} = 125°C	14.0	kA
l²t	I ² t for fusing	V _R = 0	0.98 x 10 ⁶	A ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditio	ns	Min.	Max.	Units
R _{th(j-c)}	Thermal resistance - junction to case	Double side cooled	DC	-	0.022	°CW
		Single side cooled	Anode DC	-	0.38	°CW
		2 15 32	Cathode DC	-	0.52	°CW
R _{th(c-h)}	Thermal resistance - case to heatsink	Clamping force 19.5kN	Double side	-	0.004	°CW
		(with mounting compound)	Single side	-	0.008	°CW
T _{vj}	Virtual junction temperature	On-state (conducting)		-	135	°C
		Reverse (blocking)		-	125	°C
T _{stg}	Storage temperature range			– 55	125	°C
F _m	Clamping force			18.0	22.0	kN



SURGE RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
I _{RRM} /I _{RRM}	Peak reverse and off-state current	At V _{RRM} /V _{DRM} , T _{case} = 125°C		-	150	mA
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V _{DRM} , T _j = 125°C	;	-	1000	V/μs
dI/dt	Rate of rise of on-state current	From 67% V _{DRM} ,	Repetitive 50Hz	-	30	A/μs
		Gate source 30V, 15 Ω ,	Non-repetitive	-	100	A/μs
		t _r ≤ 0.5μs, T _j = 125°C				
V _{T(TO)}	Threshold voltage	At T _{vj} = 125°C		-	1.2	V
r _T	On-state slope resistance	At T _{vj} = 125°C		-	0.98	mΩ
t _{gd}	Delay time	$V_D = 67\% V_{DRM}$, gate source 30V, 15 Ω		0.5	1.5	μs
		$t_r = 0.5 \mu s, Tj = 25^{\circ}C$				
t _q	Turn-off time	$I_T = 1000A$, $t_p = 1 ms$, $T_j = 125 °C$, $V_R = 100V$, $dI_{RR}/dt = 10A/\mu s$,		1500	-	μs
		$V_{R} = 100V, dI_{RR}/dt = 10A$	õs,			
		$V_{DR} = 67\% V_{DRM}$				
		dV _{DR} /dt = 20V/μs linear				
I _L	Latching current	$T_j = 25^{\circ}C, V_D = 10V$		-	600	mA
I _H	Holding current	$T_j = 25^{\circ}C, V_{G-K} = \infty$		-	200	mA



GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V _{GT}	Gate trigger voltage	V _{DRM} = 5V, T _{case} = 25°C	3	V
I _{GT}	Gate trigger current	V _{DRM} = 5V, T _{case} = 25°C	300	mA
V _{GD}	Gate non-trigger voltage	At V _{DRM} T _{case} = 125°C	0.25	V
V _{FGM}	Peak forward gate voltage	Anode positive with respect to cathode	30	V
V_{FGN}	Peak forward gate voltage	Anode negative with respect to cathode	0.25	V
V _{RGM}	Peak reverse gate voltage	-	5	V
I _{FGM}	Peak forward gate current	Anode positive with respect to cathode	10	А
P _{GM}	Peak gate power	See table fig. 7	150	W
$P_{G(AV)}$	Mean gate power	3 15	5	W
3000 T _j =	= 125°C	Com.cn		

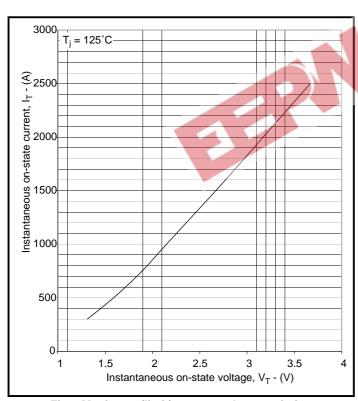
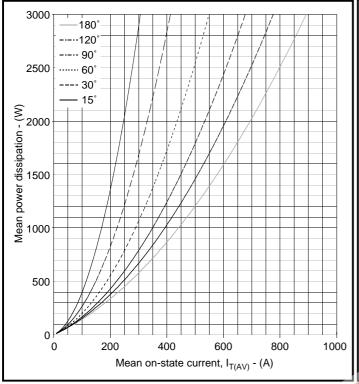


Fig.2 Maximum (limit) on-state characteristics

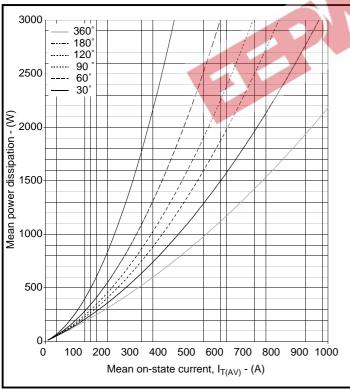




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Fig.3 Sine wave power dissipation curves

Fig.4 Sine wave power dissipation curves





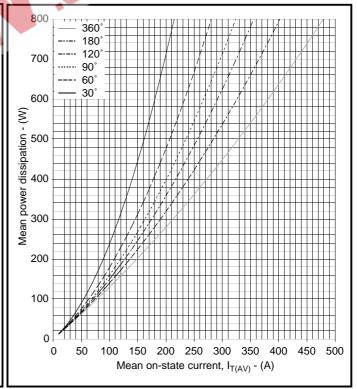


Fig.6 Square wave power dissipation curves



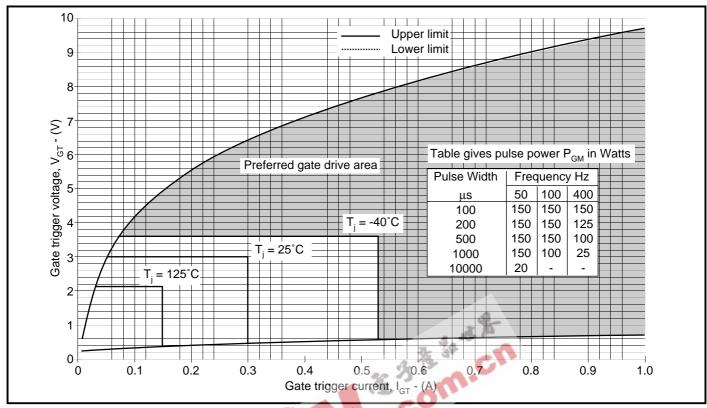


Fig.7 Gate characteristics

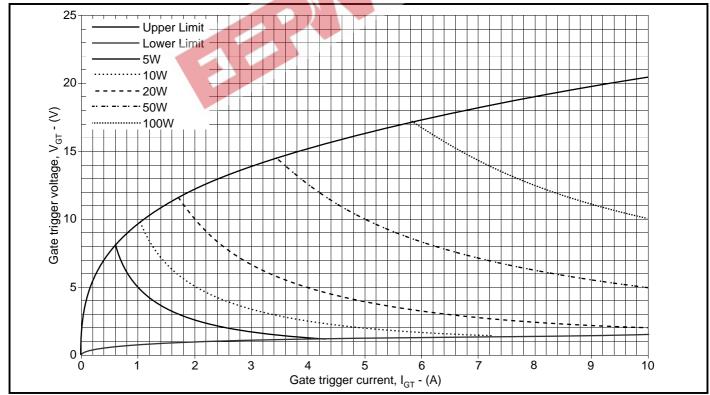
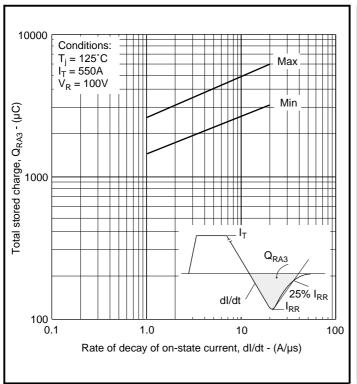


Fig.8 Gate characteristics





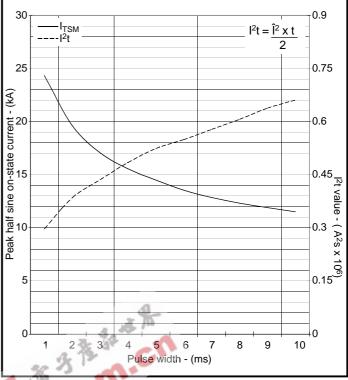


Fig.9 Stored charge

Fig.10 Surge (non-repetitive) on-state current vs time (with 50% V_{RRM} at T_{case} 125°C)

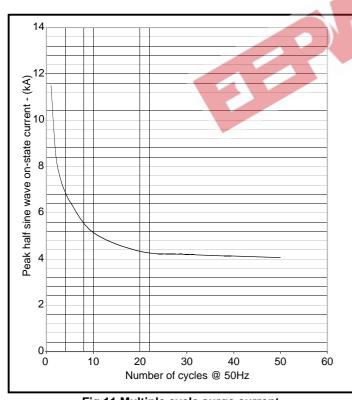


Fig.11 Multiple cycle surge current

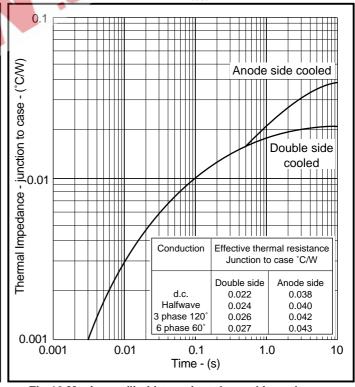
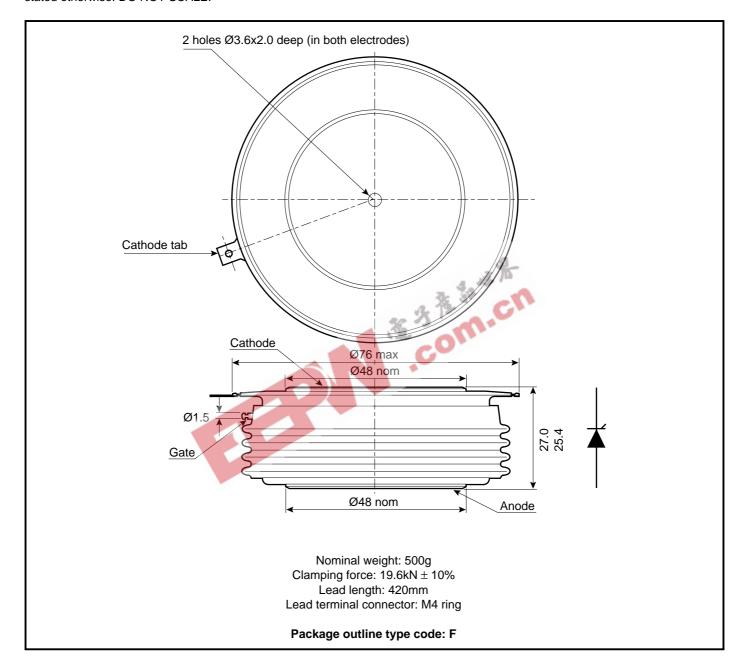


Fig.12 Maximum (limit) transient thermal impedance - junction to case (°C/W)



PACKAGE DETAILS

For further package information, please visit our website or contact your nearest Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





ASSOCIATED PUBLICATIONS

Title	Application Note	
	Number	
Calculating the junction temperature of power semiconductors	AN4506	_
Recommendations for clamping power semiconductors	AN4839	
Thyristor and diode measurement with a multi-meter	AN4853	
Use of V _{TO} , r _T on-state characteristic	AN5001	

POWER ASSEMBLY CAPABILITY

The Power Assembly group was set up to provide a support service for those customers requiring more than the basic semiconductor, and has developed a flexible range of heatsink and clamping systems in line with advances in device voltages and current capability of our semiconductors.

We offer an extensive range of air and liquid cooled assemblies covering the full range of circuit designs in general use today. The Assembly group continues to offer high quality engineering support dedicated to designing new units to satisfy the growing needs of our customers.

Using the latest CAD methods our team of design and applications engineers aim to provide the Power Assembly Complete Solution (PACs).

DEVICE CLAMPS

Disc devices require the correct clamping force to ensure their safe operation. The PACS range includes a varied selection of preloaded clamps to suit all of our manufactured devices. Types available include cube clamps for single side cooling of 'T' 23mm and 'E' 30mm discs, and bar clamps right up to 83kN for our 'Z' 100mm thyristors and diodes.

Clamps are available for single or double side cooling, with high insulation versions for high voltage assemblies.

Please refer to our application note on device clamping, AN4839

HEATSINKS

The Power Assembly group has its own proprietary range of extruded aluminium heatsinks. They have been designed to optimise the performance of Dynex semiconductors. Data with respect to air natural, forced air and liquid cooling (with flow rates) is available on request.

For further information on device clamps, heatsinks and assemblies, please contact your nearest sales representative or customer service office







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